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www.vishay.com

Vishay Semiconductors

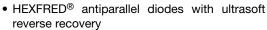
"Half Bridge" IGBT MTP (Warp Speed IGBT), 114 A



PRODUCT SUMMARY						
V_{CES}	600 V					
$V_{CE(on)}$ typical at $V_{GE} = 15 \text{ V}$	2.3 V					
I _C at T _C = 25 °C	114 A					
Speed	30 kHz to 100 kHz					
Package	MTP					
Circuit	Half bridge					

FEATURES







RoHS

- · Very low conduction and switching losses
- Optional SMD thermistor (NTC)
- Very low junction to case thermal resistance
- UL approved file E78996
- Designed and qualified for industrial level
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

BENEFITS

- · Optimized for welding, UPS and SMPS applications
- · Low EMI, requires less snubbing
- Direct mounting to heatsink
- PCB solderable terminals
- · Very low stray inductance design for high speed operation

ABSOLUTE MAXIMUM RATINGS					
PARAMETER	SYMBOL	TEST CONDITIONS	MAX.	UNITS	
Collector to emitter voltage	V _{CES}		600	V	
Continuous collector current		T _C = 25 °C	114		
Continuous collector current	Ic	T _C = 109 °C	50		
Pulsed collector current	I _{CM}		350	A	
Peak switching current	I _{LM}		350		
Diode continuous forward current	I _F	T _C = 109 °C	34		
Peak diode forward current	I _{FM}		200	1	
Gate to emitter voltage	V _{GE}		± 20	, , , , , , , , , , , , , , , , , , ,	
RMS isolation voltage	V _{ISOL}	Any terminal to case, t = 1 min	2500	V	
Maximum navvay disaination	В	T _C = 25 °C	658	W	
Maximum power dissipation	P_D	T _C = 100 °C	263] vv	





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ELECTRICAL SPECIFICATIONS (T _J = 25 °C unless otherwise specified)						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Collector to emitter breakdown voltage	V _{(BR)CES}	$V_{GE} = 0 \text{ V, } I_{C} = 500 \mu\text{A}$	600	-	-	V
		V _{GE} = 15 V, I _C = 50 A	-	2.3	3.15	
Collector to emitter voltage	V _{CE(on)}	V _{GE} = 15 V, I _C = 100 A	-	2.5	3.2	v
		V _{GE} = 15 V, I _C = 50 A, T _J = 150 °C	-	1.72	2.17	ľ
Gate threshold voltage	V _{GE(th)}	I _C = 0.5 mA	3	-	6	
Collector to emitter leaking current I _{CES}		V _{GE} = 0 V, I _C = 600 A	-	-	0.4	mA
	ICES	$V_{GE} = 0 \text{ V}, I_{C} = 600 \text{ A}, T_{J} = 150 ^{\circ}\text{C}$	-	-	10	IIIA
Diode forward voltage drop	V _{FM}	I _F = 50 A, V _{GE} = 0 V	-	1.58	1.80	
		I_F = 50 A, V_{GE} = 0 V, T_J = 150 °C	-	1.49	1.68	V
		I _F = 100 A, V _{GE} = 0 V, T _J = 25 °C	-	1.9	2.17	
Gate to emitter leakage current	I _{GES}	V _{GE} = ± 20 V	-	-	± 250	nA

SWITCHING CHARACTERISTICS (T _J = 25 °C unless otherwise specified)						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Total gate charge (turn-on)	Qg	I _C = 52 A	-	331	385	
Gate to emitter charge (turn-on)	Q _{ge}	V _{CC} = 400 V	-	44	52	nC
Gate to collector charge (turn-on)	Q _{gc}	V _{GE} = 15 V	-	133	176	
Turn-on switching loss	E _{on}	Internal gate resistors (see electrical diagram)	-	0.26	-	
Turn-off switching loss	E _{off}	$I_C = 50$ A, $V_{CC} = 480$ V, $V_{GE} = 15$ V, $L = 200$ μ H Energy losses include tail and diode reverse	-	1.2	-	mJ
Total switching loss	E _{ts}	recovery, T _J = 25 °C	-	1.46	-	
Turn-on switching loss	E _{on}	Internal gate resistors (see electrical diagram) $I_C = 50$ A, $V_{CC} = 480$ V, $V_{GE} = 15$ V, $L = 200$ μ H Energy losses include tail and diode reverse recovery, $T_J = 150$ °C	-	0.73	-	
Turn-off switching loss	E _{off}		-	1.66	-	mJ
Total switching loss	E _{ts}		-	2.39	-	
Input capacitance	C _{ies}	V _{GE} = 0 V V _{CC} = 30 V f = 1.0 MHz	-	7100	-	
Output capacitance	C _{oes}		-	510	-	pF
Reverse transfer capacitance	C _{res}		-	140	-	
Diode reverse recovery time	t _{rr}		-	82	97	ns
Diode peak reverse current	I _{rr}	$V_{CC} = 200 \text{ V, } I_{C} = 50 \text{ A}$ dl/dt = 200 A/ μ s	-	8.3	10.6	Α
Diode recovery charge	Q _{rr}		-	340	514	nC
Diode reverse recovery time	t _{rr}	V _{CC} = 200 V, I _C = 50 A dl/dt = 200 A/µs	-	137	153	ns
Diode peak reverse current	I _{rr}		-	12.7	14.8	Α
Diode recovery charge	Q _{rr}	T _J = 125 °C	-	870	1132	nC



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THERMISTOR SPECIFICATIONS						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Resistance	R ₀ ⁽¹⁾	T ₀ = 25 °C	-	30	-	kΩ
Sensitivity index of the thermistor material	β (1)(2)	T ₀ = 25 °C T ₁ = 85 °C	-	4000	-	К

Notes

 $^{(1)}$ T₀, T₁ are thermistor's temperatures

(2)
$$\frac{R_0}{R_1} = exp \left[\beta \left(\frac{1}{T_0} - \frac{1}{T_1} \right) \right]$$
, temperature in Kelvin

THERMAL AND MECHANICAL SPECIFICATIONS						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Operating junction IGBT, Diode	T.,		-40	-	150	
temperature range Thermistor			-40	-	125	°C
Storage temperature range	T _{Stg}		-40	-	125	
Junction to case			-	-	0.38	
Diode	R _{thJC}			0.8	°C/W	
Case to sink per module	R _{thCS}	Heatsink compound thermal conductivity = 1 W/mK	-	0.06	-	
Clearance (1)		External shortest distance in air between 2 terminals	5.5	-	-	
Creepage (1)		Shortest distance along the external surface of the insulating material between 2 terminals	8	-	-	mm
Mounting torque to heatsink		A mounting compound is recommended and the torque should be checked after 3 hours to allow for the spread of the compound. Lubricated threads.		3 ± 10 %		Nm
Weight				66		g

Note

⁽¹⁾ Standard version only i.e. without optional thermistor

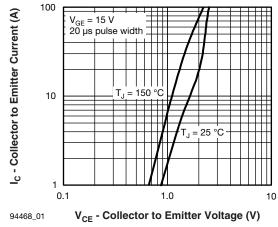


Fig. 1 - Typical Output Characteristics

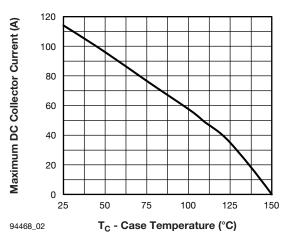


Fig. 2 - Maximum Collector Current vs. Case Temperature





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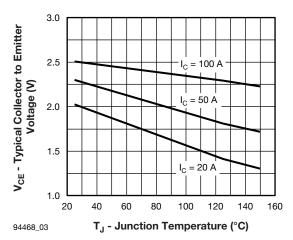


Fig. 3 - Typical Collector to Emitter Voltage vs. Junction Temperature

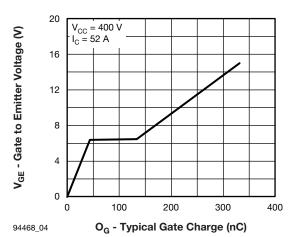


Fig. 4 - Typical Gate Charge vs. Gate to Emitter Votlage

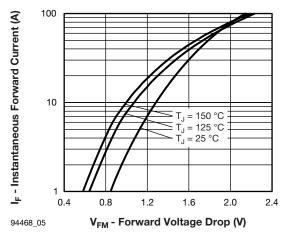


Fig. 5 - Maximum Forward Voltage Drop vs. Instantaneous Forward Current

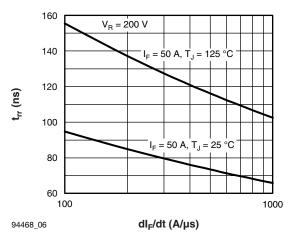


Fig. 6 - Typical Reverse Recovery Time vs. $dI_{\mbox{\scriptsize F}}/dt$

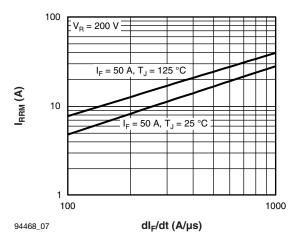


Fig. 7 - Typical Reverse Recovery Current vs. dl_F/dt

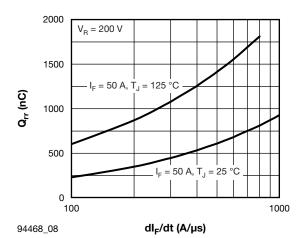
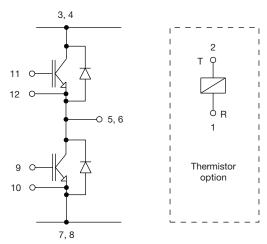


Fig. 8 - Typical Stored Charge vs. dl_F/dt

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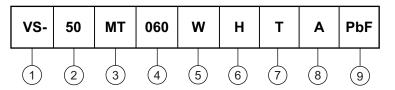
11 0 Ω 10 Ω 10 Ω 10 Ω 10 Ω 10 Ω 7, 8

Fig. 9 - Functional Diagram

Fig. 10 - Electrical Diagram

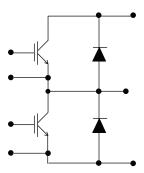
ORDERING INFORMATION TABLE

Device code



- 1 Vishay Semiconductors product
- 2 Current rating (50 = 50 A)
- 3 Essential part number
- 4 Voltage rating (060 = 600 V)
- 5 Speed/type (W = Warp IGBT)
- 6 Circuit configuration (H = Half bridge)
- 7 T = Thermistor
- 8 $A = Al_2O_3$ substrate
- 9 Lead (Pb)-free

CIRCUIT CONFIGURATION



LINKS TO RELATED DOCUMENTS				
Dimensions	www.vishay.com/doc?95175			



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